

AMENDMENTS TO THE SPECIFICATION

Please replace the first full paragraph on page 39 with the following:

The radio-conductive material may be pressed by the use of any apparatus so long as it can uniformly press the material. However it is preferred that the apparatus be provided with a temperature controller. For example, a pressing apparatus shown in Figure 9 is preferable. The substrate 103 with radio-conductive material layer 20 is placed between upper and lower heating plates 20_21 and 22 and the upper heating plate 20_21 is pressed toward the lower heating plate 22 at a uniform pressure as shown by the arrow with the four corners of the substrate 103 kept fixed. The upper heating plate 20_21 may be formed, for instance, of carbon steel SK3 and the lower heating plate 22 may be formed, for instance, of rolled steel for general structural material SS41. The higher the pressure to be applied to the radio-conductive material layer 20 is, the more the voids are removed. However, it is preferred that the pressure be not higher than 50kg/cm² so that the substrate 103 is not broken or deformed. It is preferred that the substrate 103 be heated during pressing to a temperature, which is preferably in the range of 50 to 200°C, and more preferably in the range of 120 to 190°C.